## **Surface Mount Fuses**

NANO<sup>2®</sup> > Fast Acting Fuse > 456SDE Series

## 456SDE Series Fuse





#### **Agency Approvals**

Agency	Agency File Number	Ampere Rating
c <b>FU</b> °us	E10480	40 A -60 A

#### **Electrical Characteristics**

% of Ampere Rating	Opening Time
100%	4 hours, Minimum
200%	60 seconds, Maximum

## **Additional Information**







Resources



Samples

#### **Description**

The High Current NANO<sup>2®</sup> Fuse is a small square surface mount fuse that is designed to support higher current requirements of various applications.

#### **Features**

- Available in ratings of 40 A to 60 A
- High interrupting rating of 600 A @ 80 VDC
- · Very low cold resistance, temperature rise, and voltage drop
- Surface mountable high current fuse
- UL Recognized UL/CSA/NMX 248-1 and **UL/CSA/NMX 248-14**

#### **Benefits**

- Single fuse solution for high current application
- Suitable for a wide variety of voltage requirements and applications
- · Enhances power efficiency
- Avoids nuisance opening due to high inrush and surge current inherent in the system
- · Compatible with high volume assembly requirements

#### **Applications**

- Voltage regulator Module for PC Server
- Cooling Fan System for PC Server
- Storage System Power
- Basestation Power Supply
- Power Tools

### **Electrical Specifications**

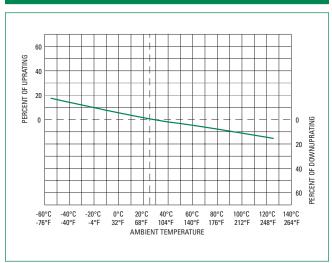
Ampere Rating (A)	Amp Code	Max Voltage Rating (V)	Interrupting Rating	Nominal Cold Resistance (Ohms) <sup>1</sup>	Nominal Melting I²t (A² Sec.) ³	Nominal Voltage Drop (mV)	Agency Approvals <sup>2</sup>
40	040.	250	150A @ 250VAC 600A @ 80VDC	0.00130	1700	110	х
50	050.	250	150A @ 250VAC 600A @ 80VDC	0.00106 2.000 116		115	х
60	060.	250	150A @ 250VAC 600A @ 80VDC	1000086		х	

#### Notes:

- 1. Cold resistance measured at less than 10% of rated current at 23° C.
- **2.** Agency Approval Table Key: X = Approved or Certified, P = Pending.
- 3. I2t values stated for 8msec opening time.



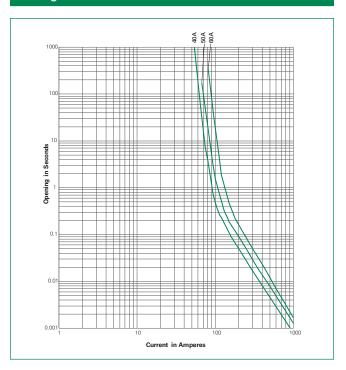
## **Temperature Re-rating Curve**



#### Note

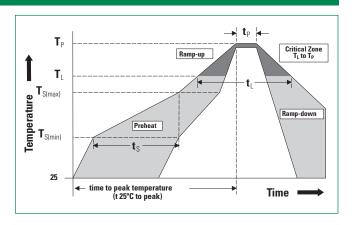
 Rerating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

## **Average Time Current Curves**



## Soldering Parameters - Reflow Soldering

Reflow Condition		Pb – Free assembly
	-Temperature Min (T <sub>s(min)</sub> )	150°C
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C
	-Time (Min to Max) (t <sub>s</sub> )	60 – 180 secs
Average ran	Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak $T_{S(\max)}$ to $T_L$ - Ramp-up Rate	
T <sub>S(max)</sub> to T <sub>L</sub> -		
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C
Retiow	- Temperature (t <sub>L</sub> )	60 – 150 seconds
Peak Temper	PeakTemperature (T <sub>p</sub> ) Time within 5°C of actual peakTemperature (t <sub>p</sub> )	
Time within		
Ramp-down	5°C/second max.	
Time 25°C to peak Temperature (T <sub>p</sub> )  Do not exceed		8 minutes max.
		260°C



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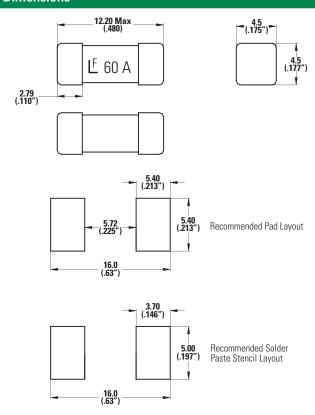
# NANO<sup>2®</sup> > Fast Acting Fuse > 456SDE Series

#### **Product Characteristics**

Materials	Body: Ceramic Cap: Silver Plated Brass		
Product Marking	Body: Brand Logo, Current Rating		
Insulation Resistance	MIL-STD-202, Method 302, Test Condition A (10,000 ohms, Minimum)		
Solderability	MIL-STD-202, Method 208		
Resistance to Soldering Heat	MIL-STD-202, Method 210, Test Condition B (10 sec at 260°C)		
PCB Recommendation for Thermal Management	Minimum copper trace width = 15 mm (40 A)/25 mm (50 A/60 A) Recommended copper trace weight = 3oz (40A) / 6oz (50 A/60 A) For PSE requirements: Minimum Copper trace width = 35mm Recommended Copper trace weight = 6oz		
	Alternate methods of thermal management may be used. In such cases, under normal operations, the maximum temperature of the fuse body should not exceed 90°C in a 25°C environment.		

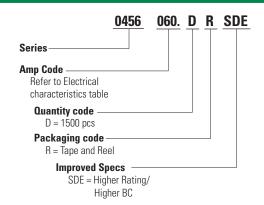
Operating Temperature	-55°C to 125°C with proper derating		
Thermal Shock	MIL-STD-202, Method 107, Test Condition B (5 cycles -65°C to 125°C)		
Vibration	MIL-STD-202, Method 201 (10-55 Hz)		
Moisture Sensitivity Level	J-STD-020, Level 1		
Moisture Resistance	MIL-STD-202 Method 106, High Humidity (90-98%RH), Heat (65°C)		
Salt Spray	MIL-STD-202, Method 101, Test Condition B		
Mechanical Shock	MIL-STD-202, Method 213, Test Condition I (100 G's peak for 6 milliseconds)		

## **Dimensions**



Note: Recommended Stencil Thickness: 0.152 mm Dimensions are in millimeters (inches)

## **Part Numbering System**



## **Packaging**

Rating	Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
40 A-60 A	24 mm Tape and Reel	EIA RS-481-2 (IEC 286, Part 3)	1500	DR

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